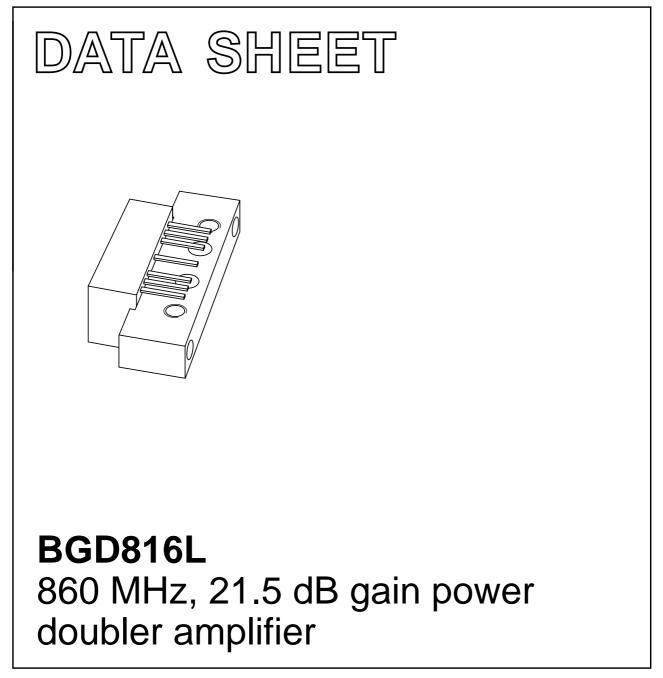
# DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2001 May 18 2001 Nov 15



### BGD816L

#### FEATURES

- Excellent linearity
- Extremely low noise
- Excellent return loss properties
- Silicon nitride passivation
- Rugged construction
- Gold metallization ensures excellent reliability.

#### APPLICATIONS

• CATV systems operating in the 40 to 870 MHz frequency range.

#### DESCRIPTION

Hybrid amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC).

#### **PINNING - SOT115J**

PIN	DESCRIPTION	
1	input	
2, 3	common	
5	+V <sub>B</sub>	
7, 8	common	
9	output	

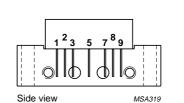


Fig.1 Simplified outline.

#### QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G <sub>p</sub>	power gain	f = 45 MHz	21.2	21.8	dB
		f = 870 MHz	22	23	dB
I <sub>tot</sub>	total current consumption (DC)	V <sub>B</sub> = 24 V	345	375	mA

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER		MAX.	UNIT
V <sub>B</sub>	supply voltage		30	V
Vi	RF input voltage		70	dBmV
T <sub>stg</sub>	storage temperature		+100	°C
T <sub>mb</sub>	operating mounting base temperature		+100	°C

### BGD816L

### CHARACTERISTICS

Bandwidth 40 to 870 MHz; V\_B = 24 V; T\_mb = 35 °C; Z\_S = Z\_L = 75  $\Omega$ 

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
G <sub>p</sub>	power gain	f = 45 MHz	21.2	-	21.8	dB
		f = 870 MHz	22	-	23	dB
SL	slope straight line	f = 45 to 870 MHz; note 1		1	1.5	dB
FL	flatness straight line	f = 45 to 100 MHz	-	-	±0.25	dB
		f = 100 to 800 MHz	-	-	±0.5	dB
		f = 800 to 870 MHz	-0.4	-	0.1	dB
S <sub>11</sub>	input return losses	f = 45 to 80 MHz	22	-	-	dB
		f = 80 to 160 MHz	21	-	-	dB
		f = 160 to 320 MHz	19	-	-	dB
		f = 320 to 550 MHz	18	-	-	dB
		f = 550 to 650 MHz	17	-	-	dB
		f = 650 to 750 MHz	16	-	-	dB
		f = 750 to 870 MHz	15	-	-	dB
		f = 870 to 914 MHz	12	-	-	dB
\$ <sub>22</sub>	output return losses	f = 45 to 80 MHz	25	-	-	dB
		f = 80 to 160 MHz	23	-	_	dB
		f = 160 to 320 MHz	18	-	_	dB
		f = 320 to 550 MHz	17	_	_	dB
		f = 550 to 650 MHz	16	-	_	dB
		f = 650 to 750 MHz	15	-	_	dB
		f = 750 to 870 MHz	15	_	_	dB
		f = 870 to 914 MHz	12	-	-	dB
s <sub>21</sub>	phase response	f = 50 MHz	-45	-	+45	deg
СТВ	composite triple beat	79 chs flat; $V_o = 44 \text{ dBmV}$ ; $f_m = 547.25 \text{ MHz}$	_	-	-66	dB
		112 chs flat; $V_0 = 44 \text{ dBmV}$ ; $f_m = 745.25 \text{ MHz}$	_	-	-59.5	dB
		132 chs flat; $V_o = 44 \text{ dBmV}$ ; $f_m = 859.25 \text{ MHz}$	_	-	-55	dB
		112 chs; $f_m = 547.25$ MHz; $V_o = 48.2$ dBmV at 745 MHz; note 2	-	-	-59	dB
		79 chs; $f_m$ = 331.25 MHz; $V_o$ = 45.3 dBmV at 547 MHz; note 3	-	-	-68.5	dB
X <sub>mod</sub>	cross modulation	79 chs flat; $V_o = 44$ dBmV; $f_m = 55.25$ MHz	-	-	-64	dB
		112 chs flat; $V_o = 44 \text{ dBmV}$ ; $f_m = 55.25 \text{ MHz}$	-	-	-61	dB
		132 chs flat; $V_0 = 44 \text{ dBmV}$ ; $f_m = 55.25 \text{ MHz}$	-	_	-58	dB
		112 chs; $f_m = 745.25$ MHz; $V_o = 48.2$ dBmV at 745 MHz; note 2	-	-	-60	dB
		79 chs; $f_m = 445.25$ MHz; $V_o = 45.3$ dBmV at 547 MHz; note 3	-	-	-66	dB

### BGD816L

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
CSO	composite second order distortion	79 chs flat; $V_o = 44 \text{ dBmV}$ ; $f_m = 548.5 \text{ MHz}$	-	-	-66	dB
		112 chs flat; V <sub>o</sub> = 44 dBmV; f <sub>m</sub> = 746.5 MHz	_	_	-58	dB
		132 chs flat; V <sub>o</sub> = 44 dBmV; f <sub>m</sub> = 860.5 MHz	_	-	-56	dB
		112 chs; $f_m = 210.0 \text{ MHz}$ ; $V_o = 48.2 \text{ dBmV}$ at 745 MHz; note 2	-	-	-57	dB
		79 chs; $f_m$ = 210.0 MHz; $V_o$ = 45.3 dBmV at 547 MHz; note 3	-	-	-64	dB
d <sub>2</sub>	second order distortion	note 4		-	-70	dB
V <sub>o</sub> oo	output voltage	d <sub>im</sub> = –60 dB; note 5	62	-	-	dBmV
		CTB compression = 1 dB; 132 chs flat; f = 859.25 MHz	48	-	-	dBmV
		CSO compression = 1 dB; 132 chs flat; f = 860.5 MHz	49	-	-	dBmV
NF	noise figure	f = 50 MHz	-	-	5.5	dB
		f = 550 MHz	_	-	5.5	dB
		f = 750 MHz	_	-	6.5	dB
		f = 870 MHz	_	-	7.5	dB
I <sub>tot</sub>	total current consumption (DC)	note 6		360	375	mA

#### Notes

- 1. Slope straight line is defined as gain at 870 MHz against gain at 45 MHz.
- 2. Tilt = 10.2 dB (55 to 745 MHz).
- 3. Tilt = 7.3 dB (55 to 547 MHz).
- 5. Measured according to DIN45004B:
  - $\begin{array}{l} f_{p}=851.25 \text{ MHz}; \ V_{p}=V_{o}; \\ f_{q}=858.25 \text{ MHz}; \ V_{q}=V_{o}-6 \text{ dB}; \\ f_{r}=860.25 \text{ MHz}; \ V_{r}=V_{o}-6 \text{ dB}; \\ \text{measured at } f_{p}+f_{q}-f_{r}=849.25 \text{ MHz}. \end{array}$
- 6. The module normally operates at  $V_B = 24$  V, but is able to withstand supply transients up to 35 V.

Α

max.

OUTLINE

VERSION

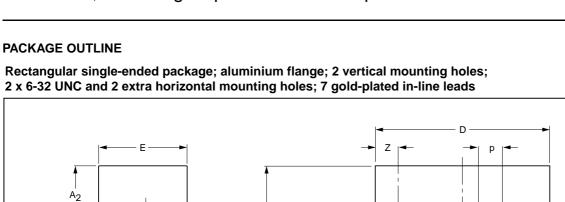
SOT115J

UNIT

mm 20.8 9.1

A2

max



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EUROPEAN

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**ISSUE DATE** 

99-02-06

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DIMENSIONS (mm are the original dimensions)

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JEDEC

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# 860 MHz, 21.5 dB gain power doubler amplifier

**BGD816L** 

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SOT115J

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4.15 3.85

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min.

F

REFERENCES

e<sub>1</sub>

5.08 12.7 8.8 10 mm

Q

max

2.4 38.1 25.4 10.2 4.2 44.75 8

q q1

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#### DATA SHEET STATUS

DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
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#### Notes

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#### CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

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NOTES

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#### **Contact information**

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Printed in The Netherlands

613518/05/pp8

Date of release: 2001 Nov 15

Document order number: 9397 750 08862

SCA73

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